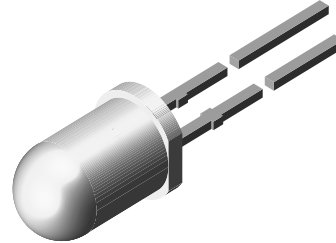


High Efficiency Blue LED, \varnothing 5 mm Tinted Diffused Package

Description

This device has been redesigned in 1998 replacing SiC by GaN technology to meet the increasing demand for high efficiency blue LEDs.

It is housed in a 5 mm tinted diffused plastic package. All packing units are categorized in luminous intensity groups. That allows users to assemble LEDs with uniform appearance.



19223



Features

- GaN on SiC technology
- Standard \varnothing 5 mm T-1 $\frac{3}{4}$ package
- Small mechanical tolerances
- Wide viewing angle
- Very high intensity
- Luminous intensity categorized
- ESD class 1
- Lead-free device

Applications

Status lights
 OFF / ON indicator
 Background illumination
 Readout lights
 Maintenance lights
 Legend light

Parts Table

Part	Color, Luminous Intensity	Angle of Half Intensity ($\pm\phi$)	Technology
TLHB5400	Blue, $I_V > 6.3$ mcd	30 °	GaN on SiC
TLHB5401	Blue, $I_V = (10 \text{ to } 32)$ mcd	30 °	GaN on SiC

Absolute Maximum Ratings

$T_{amb} = 25$ °C, unless otherwise specified

TLHB540.

Parameter	Test condition	Symbol	Value	Unit
Reverse voltage		V_R	5	V
DC Forward current	$T_{amb} \leq 65$ °C	I_F	20	mA
Surge forward current	$t_p \leq 10$ μ s	I_{FSM}	0.1	A
Power dissipation	$T_{amb} \leq 65$ °C	P_V	100	mW
Junction temperature		T_j	100	°C
Operating temperature range		T_{amb}	- 40 to + 100	°C
Storage temperature range		T_{stg}	- 40 to + 100	°C
Soldering temperature	$t \leq 5$ s, 2 mm from body	T_{sd}	260	°C
Thermal resistance junction/ambient		R_{thJA}	350	K/W

Optical and Electrical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Blue

TLHB540.

Parameter	Test condition	Part	Symbol	Min	Typ.	Max	Unit
Luminous intensity ¹⁾	$I_F = 20\text{ mA}$	TLHB5400	I_V	6.3	15		mcd
		TLHB5401	I_V	10		32	mcd
Dominant wavelength	$I_F = 10\text{ mA}$		λ_d		466		nm
Peak wavelength	$I_F = 10\text{ mA}$		λ_p		428		nm
Angle of half intensity	$I_F = 10\text{ mA}$		ϕ		± 30		deg
Forward voltage	$I_F = 20\text{ mA}$		V_F		3.9	4.5	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$		V_R	5			V

¹⁾ in one Packing Unit $I_{Vmin}/I_{Vmax} \leq 0.5$

Typical Characteristics ($T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

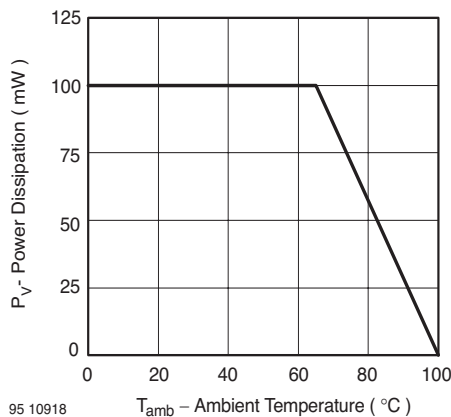


Figure 1. Power Dissipation vs. Ambient Temperature

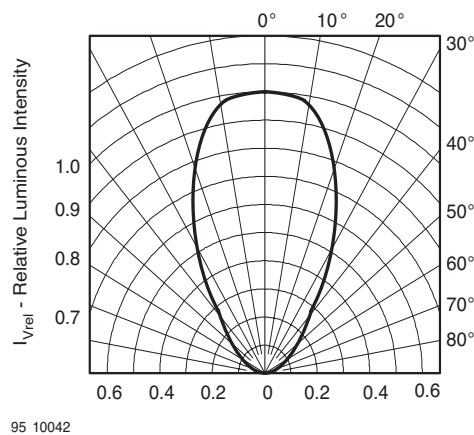


Figure 3. Rel. Luminous Intensity vs. Angular Displacement

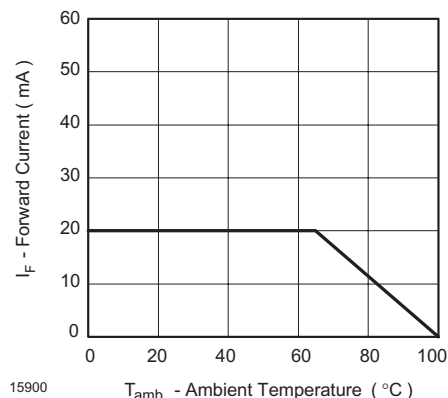


Figure 2. Forward Current vs. Ambient Temperature

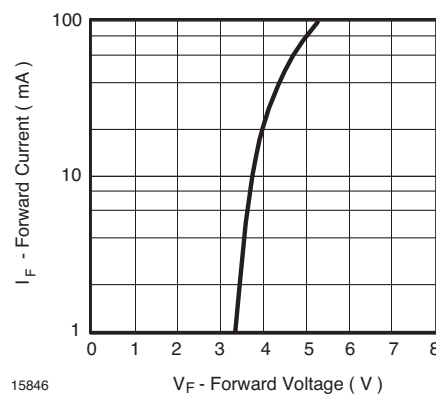


Figure 4. Forward Current vs. Forward Voltage

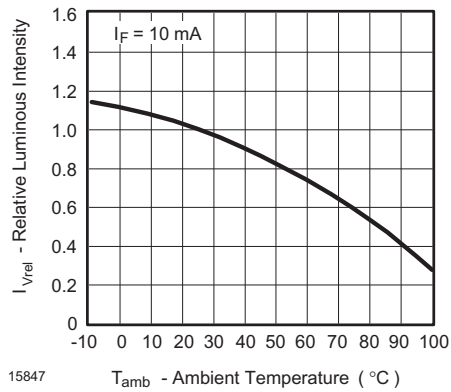


Figure 5. Rel. Luminous Flux vs. Ambient Temperature

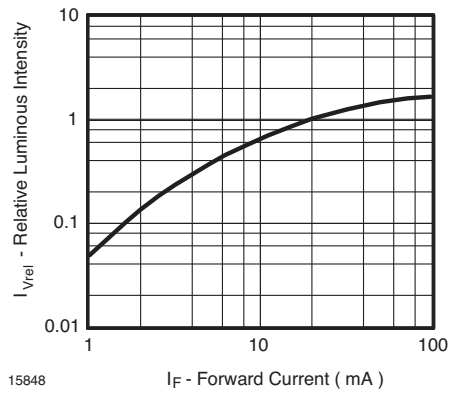


Figure 6. Relative Luminous Flux vs. Forward Current

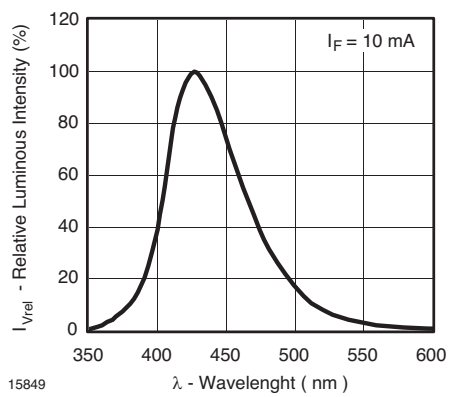
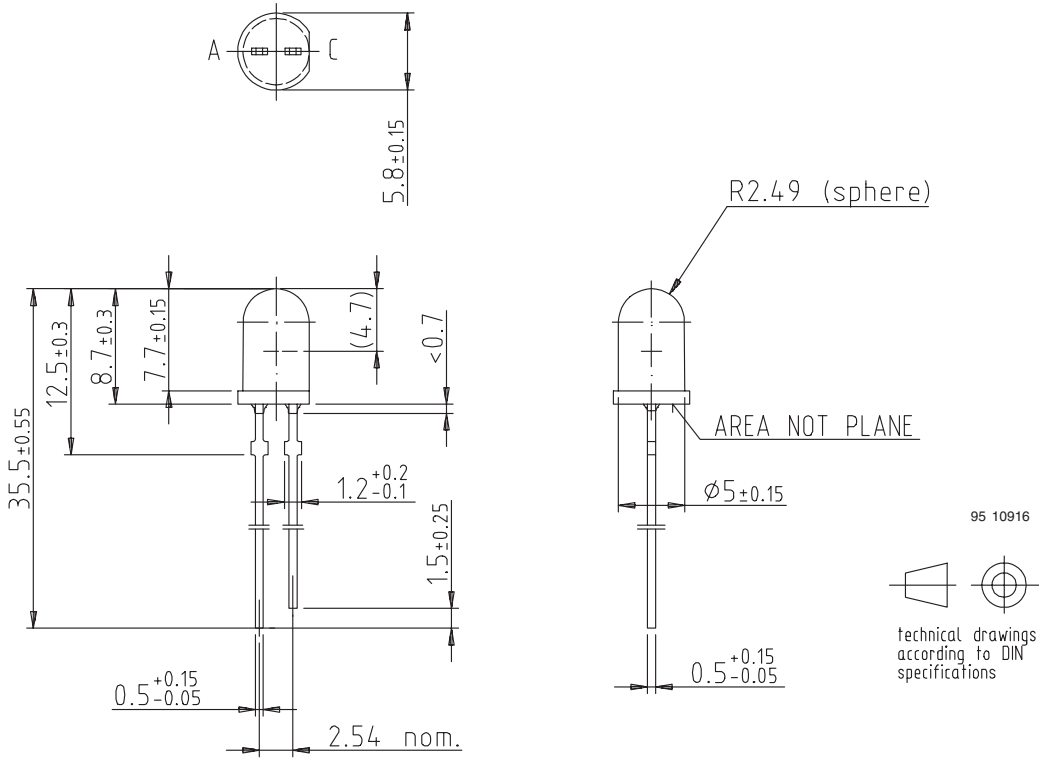


Figure 7. Relative Intensity vs. Wavelength

Package Dimensions in mm



Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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